TDK Chip Beads

MPZ1005S121CT000

Applications	Commercial Grade
Feature	Power Line
Series	MPZ Series / MPZ1005 Type
Status	Production



Size	
Length(L)	1.00mm +/-0.05mm
Width(W)	0.50mm +/-0.05mm
Thickness(T)	0.50mm +/-0.05mm
Recommended Land Pattern (A)	0.50mm Nom.
Recommended Land Pattern (B)	0.40mm Nom.
Recommended Land Pattern (C)	0.50mm Nom.

Electrical Characteristics		
Impedance at 100MHz	120Ω +/-25%	
Rated Current	1.2A	
DC Resistance [Max.]	90mΩ	

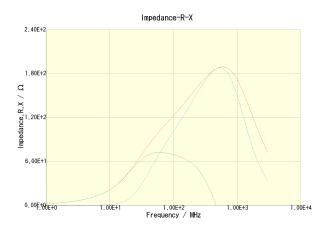
Other		
Operating Temp. Range (Including Self-Temp. Rise)	-55 to 125degC	
Soldering Method	Reflow, Iron Soldering	
AEC Q200	No	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	10000Pcs Min.	
Weight	0.001g	

•This PDF document was created based on the data listed on the TDK Corporation website.

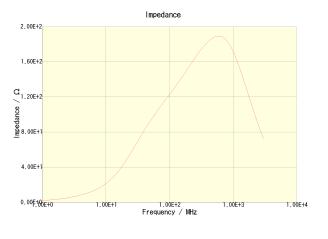
•All specifications are subject to change without notice.

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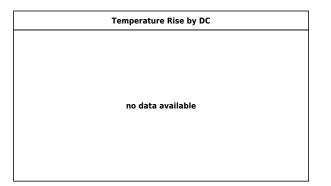
Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)



MPZ1005S121CT000(|Z|)PZ1005S121CT000(R)MPZ1005S121CT000(X)



MPZ1005S121CT000



Derating	
no data available	

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